

# 2SK2645-01MR FAP-IIS Series

N-channel MOS-FET
600V 1,2Ω 9A 50W

#### > Features

- High Speed Switching
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- Vgs = ± 30V Guarantee
- Repetitive Avalanche Rated

# > Applications

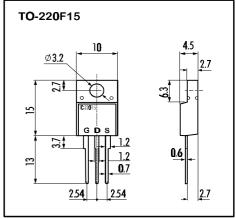
- Switching Regulators
- UPS
- DC-DC converters
- General Purpose Power Amplifier

## > Maximum Ratings and Characteristics

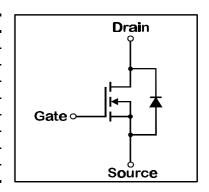
Absolute Maximum RatingsT( C=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V <sub>DS</sub>	600	V
Continous Drain Current	ΙD	9	Α
Pulsed Drain Current	I <sub>D(puls)</sub>	32	Α
Gate-Source-Voltage	V <sub>GS</sub>	±30	V
Repetitive or Non-Repetitive (T <sub>ch</sub> ≤ 150°C)	I AR	9	Α
Avalanche Energy	E AS	71,9	mJ
Max. Power Dissipation	P <sub>D</sub>	50	W
Operating and Storage Temperature Range	T ch	150	°C
	T <sub>stg</sub>	-55 ~ +150	°C

# > Outline Drawing



### > Equivalent Circuit



#### - Electrical Characteristics (T<sub>C</sub>=25°C), unless otherwise specified

Item	Symbol	Test conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown-Voltage	V <sub>(BR)DSS</sub>	$I_D=1mA$	$V_{GS}$ =0 $V$	600			V
Gate Threshhold Voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =1mA	$V_{DS=}V_{GS}$	3,5	4,0	4,5	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =600V	T <sub>ch</sub> =25°C		10	500	μA
		$V_{GS}=0V$	T <sub>ch</sub> =125°C		0,2	1,0	mA
Gate Source Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm30V$	$V_{DS}=0V$		10	100	nA
Drain Source On-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =4A	V <sub>GS</sub> =10V		1,0	1,2	Ω
Forward Transconductance	g fs	I <sub>D</sub> =4A	$V_{DS}=25V$	2,5	5		S
Input Capacitance	C iss	٧	/ <sub>DS</sub> =25V		900	1400	pF
Output Capacitance	C oss	,	$V_{GS}=0V$		150	230	pF
Reverse Transfer Capacitance	C rss	f	f=1MHz		70	110	pF
Turn-On-Time t <sub>on</sub> (t <sub>on</sub> =t <sub>d(on)</sub> +t <sub>r</sub> )	t <sub>d(on)</sub>	V	<sub>CC</sub> =300V		25	40	ns
	t r		I <sub>D</sub> =9A		70	110	ns
Turn-Off-Time t <sub>off</sub> (t <sub>on</sub> =t <sub>d(off)</sub> +t <sub>f</sub> )	t d(off)	\	/ <sub>GS</sub> =10V		60	90	ns
	t f	R	$_{\text{GS}}$ =10 $\Omega$		35	60	ns
Avalanche Capability	I AV	$L = 100 \mu H$	T <sub>ch</sub> =25°C	9			Α
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>F</sub> =2xI <sub>DR</sub> V	<sub>GS</sub> =0V T <sub>ch</sub> =25°C		1,0	1,5	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =I <sub>C</sub>	or V <sub>GS</sub> =0V		550		ns
Reverse Recovery Charge	Q n	-dl <sub>F</sub> /dt=10	00A/μs T <sub>ch</sub> =25°C		7,0		μC

#### Thermal Characteristics

Thermal Characteristics						
Item	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance	R <sub>th(ch-a)</sub>	channel to air			62,5	°C/W
	R <sub>th(ch-c)</sub>	channel to case			2,5	°C/W

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#### > Characteristics

